

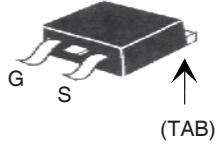
# TrenchP™ Power MOSFET

P-Channel Enhancement Mode  
Avalanche Rated

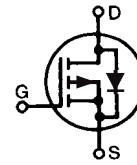
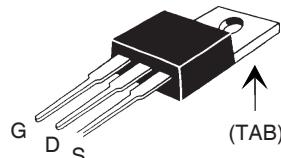
## IXTA44P15T IXTP44P15T IXTQ44P15T IXTH44P15T

$V_{DSS}$  = - 150V  
 $I_{D25}$  = - 44A  
 $R_{DS(on)}$   $\leq$  65mΩ

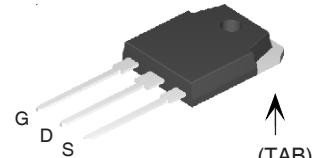
TO-263 (IXTA)



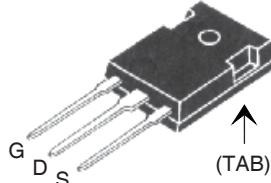
TO-220 (IXTP)



TO-3P (IXTQ)



TO-247 (IXTH)



G = Gate      D = Drain  
 S = Source      TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_j = 25^\circ\text{C}$ to $150^\circ\text{C}$	- 150		V
$V_{BGR}$	$T_j = 25^\circ\text{C}$ to $150^\circ\text{C}$ , $R_{GS} = 1\text{M}\Omega$	- 150		V
$V_{GSS}$	Continuous	$\pm 20$		V
$V_{GSM}$	Transient	$\pm 30$		V
$I_{D25}$	$T_c = 25^\circ\text{C}$	- 44		A
$I_{DM}$	$T_c = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	-130		A
$I_A$	$T_c = 25^\circ\text{C}$	- 22		A
$E_{AS}$	$T_c = 25^\circ\text{C}$	1		J
$P_D$	$T_c = 25^\circ\text{C}$	298		W
$T_J$		-55 ... +150		$^\circ\text{C}$
$T_{JM}$		150		$^\circ\text{C}$
$T_{stg}$		-55 ... +150		$^\circ\text{C}$
$T_L$	1.6mm (0.062 in.) from case for 10s	300		$^\circ\text{C}$
$T_{SOLD}$	Plastic body for 10s	260		$^\circ\text{C}$
$M_d$	Mounting torque (TO-220)(TO-247)(TO-3P)	1.13/10	Nm/lb.in.	
<b>Weight</b>	TO-263 TO-220 TO-3P TO-247	2.5 3.0 5.5 6.0	g	g

Symbol	Test Conditions ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0\text{V}$ , $I_D = - 250\mu\text{A}$	-150		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = - 250\mu\text{A}$	- 2.0		V
$I_{GSS}$	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$		$\pm 100$	nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{V}$		- 15	$\mu\text{A}$
			- 750	$\mu\text{A}$
$R_{DS(on)}$	$V_{GS} = -10\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1		65	mΩ

### Features

- International standard packages
- Avalanche Rated
- Fast intrinsic diode
- Low  $Q_G$  and  $R_{ds(on)}$
- Extended FBSOA

### Advantages

- Low gate drive requirement
- High power density
- Fast switching

### Applications

- Load switches
- High side switches
- Low voltage applications such as automotive, DC & DC converters
- SMPS
- Inverters and battery chargers
- Audio and Medical applications



**IXTA44P15T IXTP44P15T**  
**IXTQ44P15T IXTH44P15T**

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = -10\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1	27	45	S
$C_{iss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = -25\text{V}$ , $f = 1\text{MHz}$	13.4	nF	
$C_{oss}$		675	pF	
$C_{rss}$		183	pF	
$t_{d(on)}$	<b>Resistive Switching Times</b> $V_{GS} = -10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$ $R_G = 1\Omega$ (External)	25	ns	
$t_r$		42	ns	
$t_{d(off)}$		50	ns	
$t_f$		17	ns	
$Q_{g(on)}$	$V_{GS} = -10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	175	nC	
$Q_{gs}$		65	nC	
$Q_{gd}$		58	nC	
$R_{thJC}$			0.42	°C/W
$R_{thCS}$	(TO-220) (TO-247)(TO-3P)	0.50 0.25	°C/W °C/W	°C/W

#### Source-Drain Diode

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		- 44	A
$I_{SM}$	Repetitive, pulse width limited by $T_{JM}$		-176	A
$V_{SD}$	$I_F = -22\text{A}$ , $V_{GS} = 0\text{V}$ , Note 1		-1.3	V
$t_{rr}$	$I_F = -22\text{A}$ , $-di/dt = -100\text{A}/\mu\text{s}$ $V_R = -75\text{V}$ , $V_{GS} = 0\text{V}$	140	ns	
$Q_{RM}$		0.87	μC	
$I_{RM}$		-12.4	A	

Note 1: Pulse test,  $t \leq 300\mu\text{s}$ ; duty cycle,  $d \leq 2\%$ .

#### PRELIMINARY TECHNICAL INFORMATION

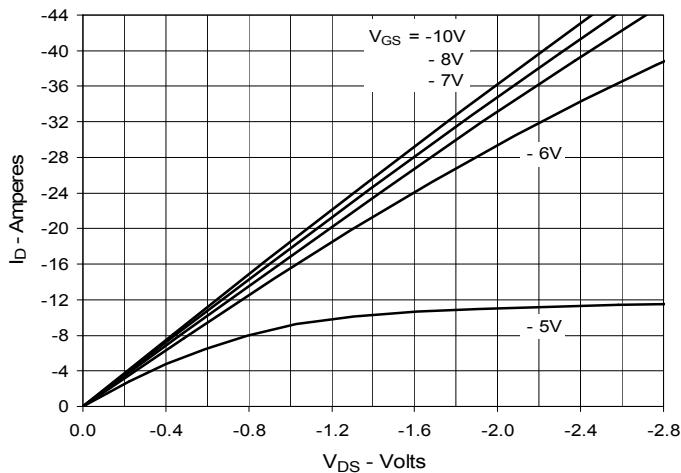
The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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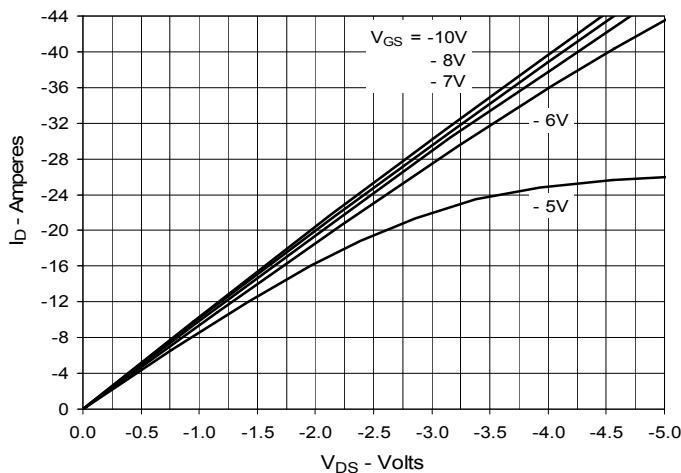
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537



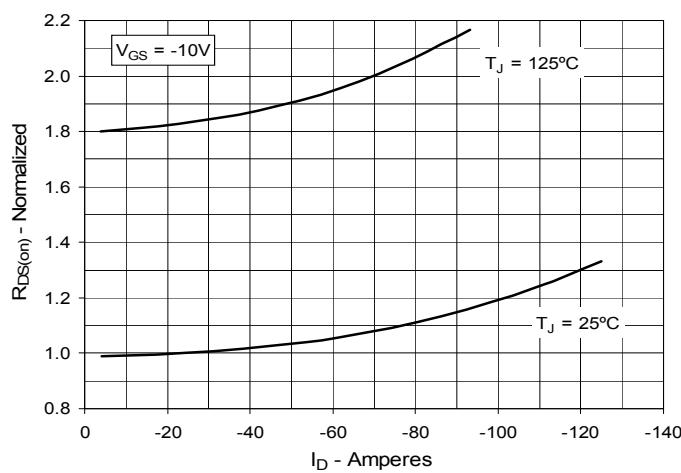
**Fig. 1. Output Characteristics  
@ 25°C**



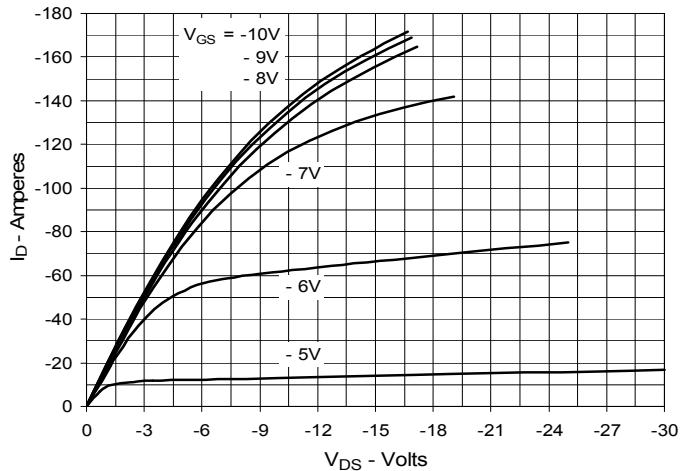
**Fig. 3. Output Characteristics  
@ 125°C**



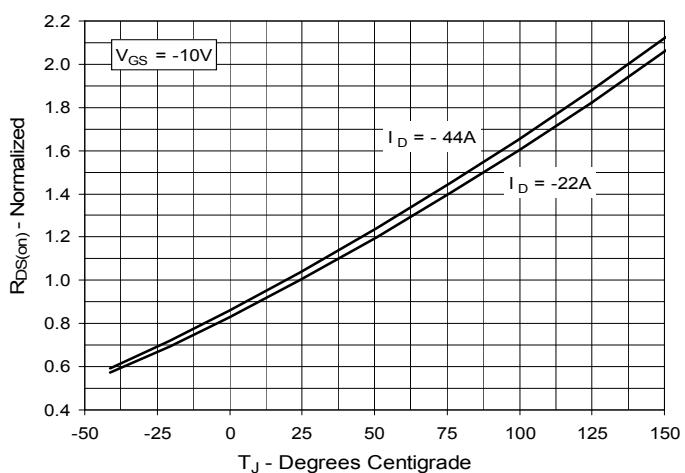
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = -22A$  vs.  
Drain Current**

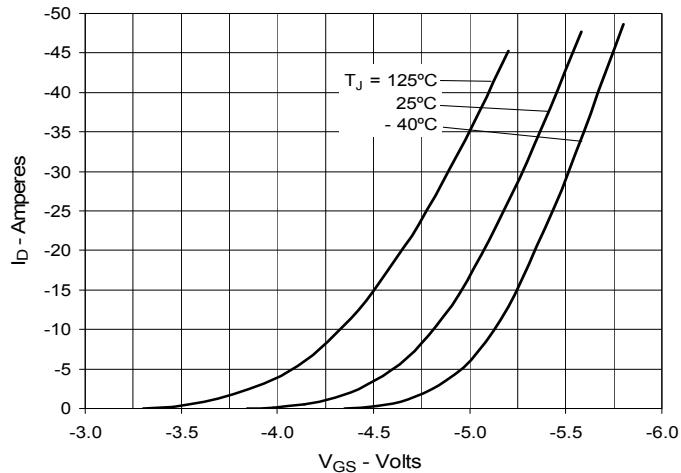
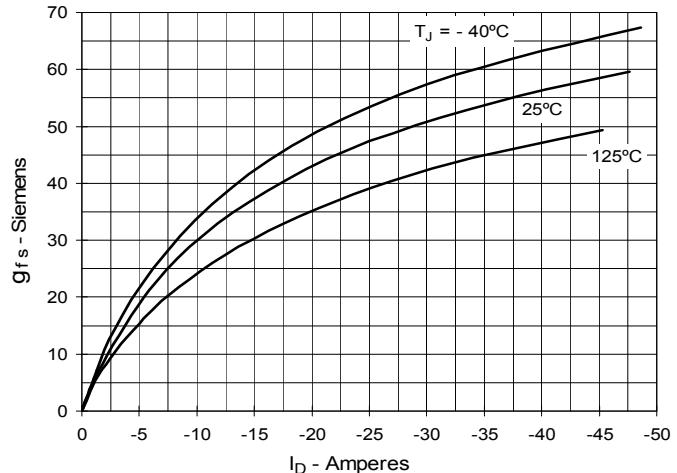
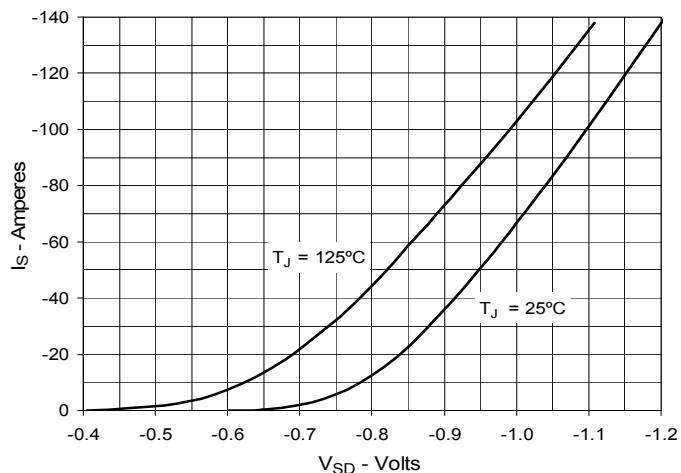
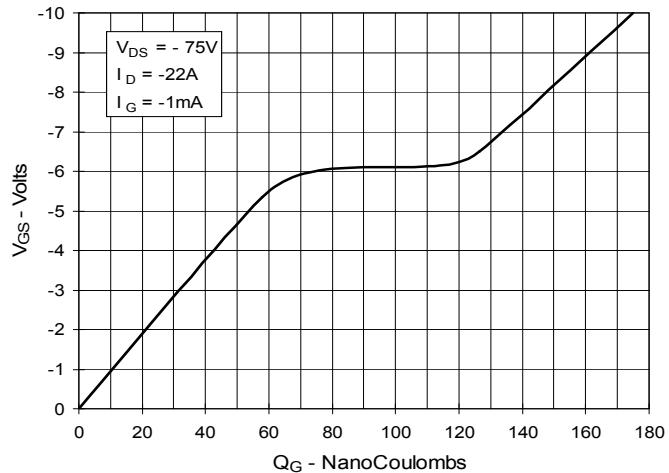
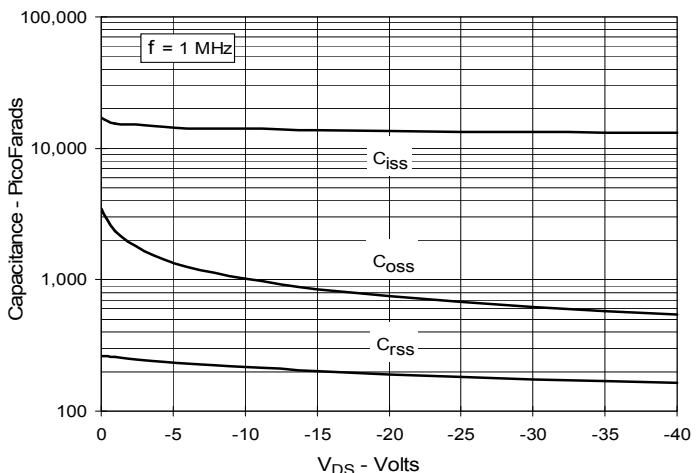
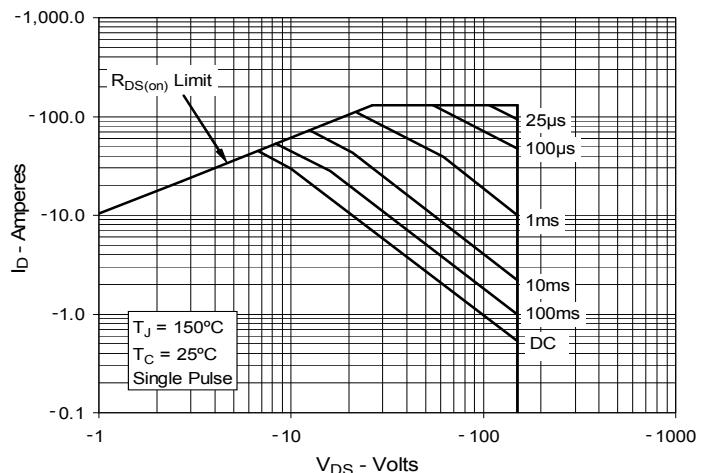


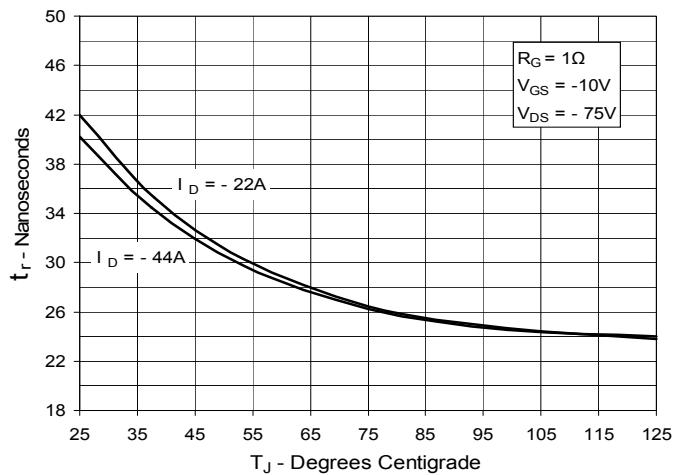
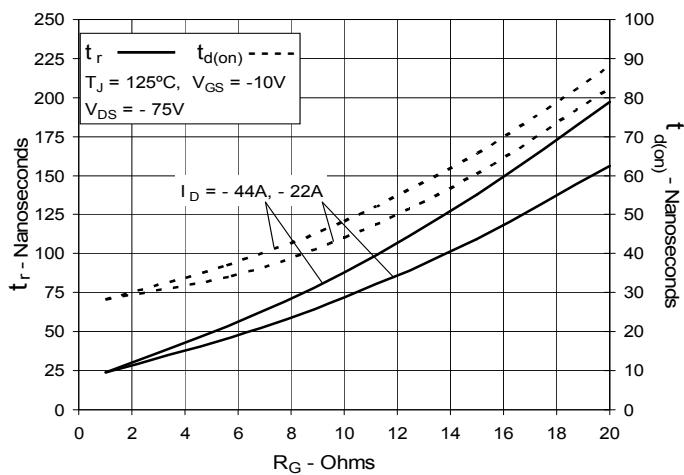
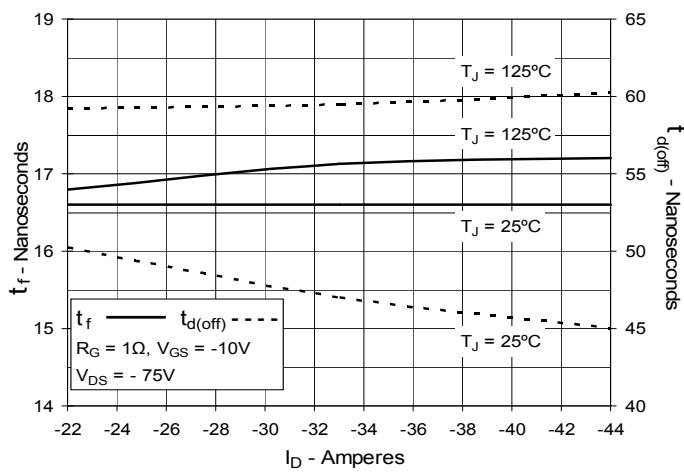
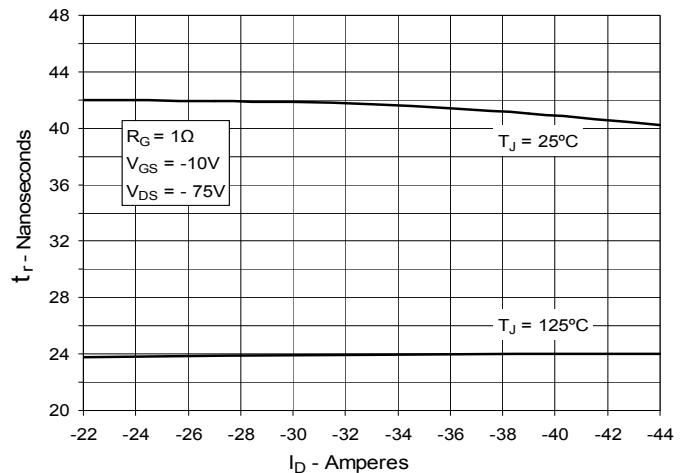
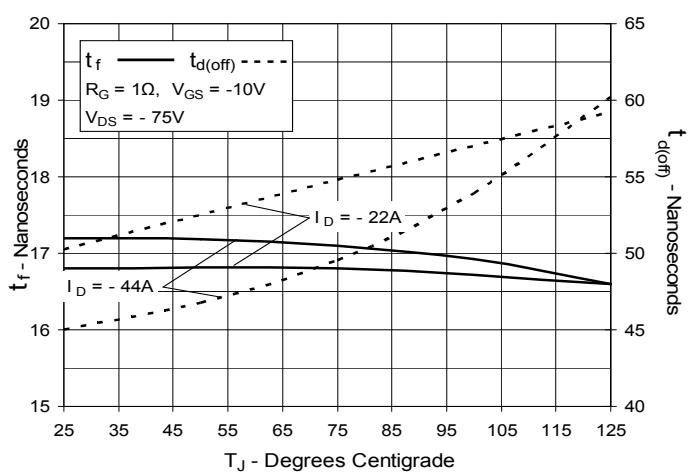
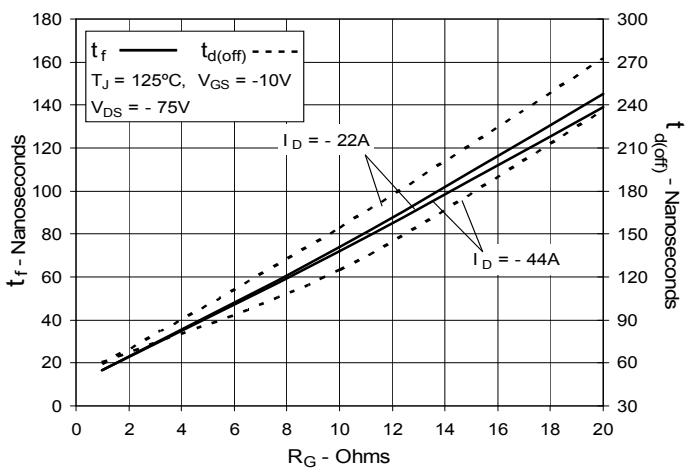
**Fig. 2. Extended Output Characteristics  
@ 25°C**



**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = -22A$  vs.  
Junction Temperature**



**Fig. 7. Input Admittance**

**Fig. 8. Transconductance**

**Fig. 9. Forward Voltage Drop of Intrinsic Diode**

**Fig. 10. Gate Charge**

**Fig. 11. Capacitance**

**Fig. 12. Forward-Bias Safe Operating Area**


**Fig. 13. Resistive Turn-on**  
**Rise Time vs. Junction Temperature**

**Fig. 15. Resistive Turn-on**  
**Switching Times vs. Gate Resistance**

**Fig. 17. Resistive Turn-off**  
**Switching Times vs. Drain Current**

**Fig. 14. Resistive Turn-on**  
**Rise Time vs. Drain Current**

**Fig. 16. Resistive Turn-off**  
**Switching Times vs. Junction Temperature**

**Fig. 18. Resistive Turn-off**  
**Switching Times vs. Gate Resistance**


**Fig. 19. Maximum Transient Thermal Impedance**